

# Full Color PCB Type SMD LED VAOL-S2223RGB

#### **Features**

- Package in 8mm tape on a 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- RoHS compliant version.



- The SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density and reduced storage space and finally smaller equipment to be obtained.
- Light weigh makes them ideal for miniature applications.



#### **Device Selection Guide**

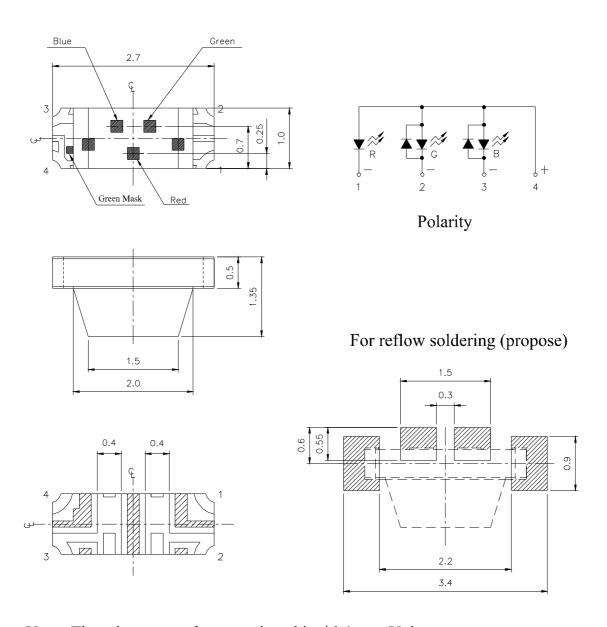
	I Cala			
Туре	Material	<b>Emitted Color</b>	Lens Color	
R6	AlInGaN	Brilliant Red		
GH	InGaN	Brilliant Green	Water Clear	
ВН	InGaN	Blue		







# **Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm







# Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	Vr	5	V	
	IF	R6:25		
Forward Current		GH:25	mA	
		BH:25		
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\! \mathbb{C}$	
Storage Temperature	Tstg	<b>-</b> 40 ∼ +90	$^{\circ}$ C	
	Pd	R6:60		
Power Dissipation		GH:110	mW	
		BH:110		
Peak Forward Current	IFP	R6:60		
(Duty 1/10 @1KHz)		GH:100	mA	
(Duty 1/10 (@1KHz)		BH:100		
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 see Hand Soldering: 350 °C for 3 sec.		

Specific binning requirements- please contact our home office







# Electro-Optical Characteristics (Ta=25°C)

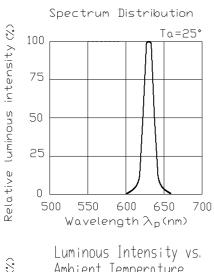
Parameter	Symbol		Min.	Тур.	Max.	Unit	Condition
		R6	45	72			
Luminous Intensity	Iv	GH	112	180		med	I <sub>F</sub> =20mA
		ВН	28.5	45			
Viewing Angle $\theta$	2	1/2		120		deg	I <sub>F</sub> =20mA
		R6		632			
Peak Wavelength	λp	GH		518		nm	I <sub>F</sub> =20mA
		ВН		468			
Dominant Wavelength		R6	615		630		
	λd	GH	510		540	nm	I <sub>F</sub> =20mA
		ВН	460		480		
		R6		20			
Spectrum Radiation Bandwidth	Δλ	GH		35		nm	I <sub>F</sub> =20mA
		ВН		35			
		R6	1.7	2.0	2.4		
Forward Voltage	VF	GH	2.7	3.3	3.7	V	I <sub>F</sub> =20mA
		ВН	2.7	3.3	3.7		
		R6			10		
Reverse Current	Ir	GH			50	$\mu$ A	$V_R=5V$
		ВН			50		

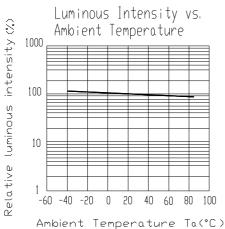


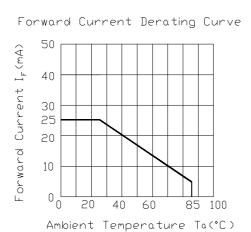


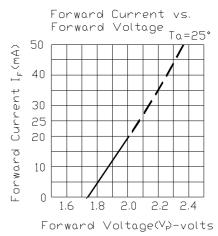
#### **Typical Electro-Optical Characteristics Curves**

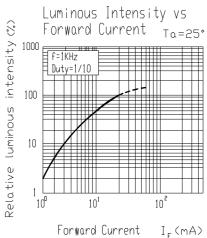
## **R6**

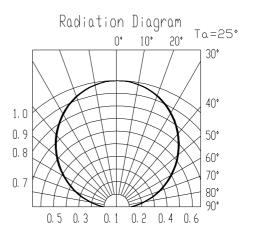
















Relative luminous intensity (%)

1000

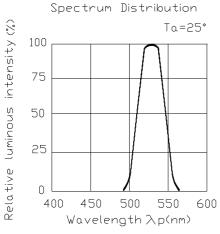
100

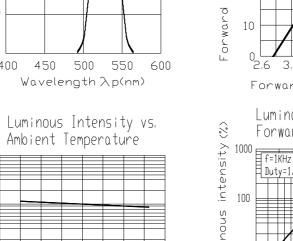
10

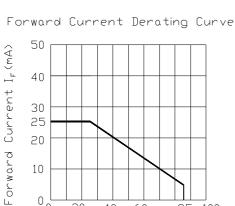
-40 -20

#### **Typical Electro-Optical Characteristics Curves**

## GH

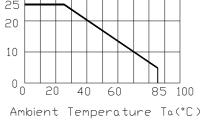


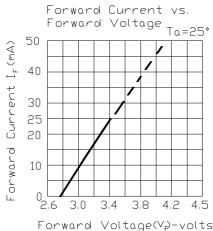


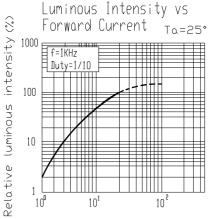


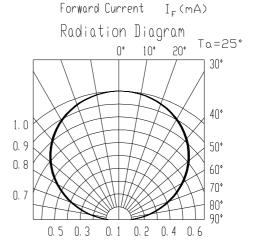
0 20 40 60 80

Ambient Temperature Ta(°C)







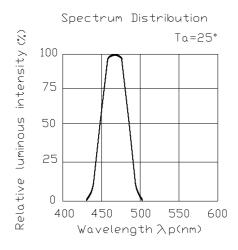


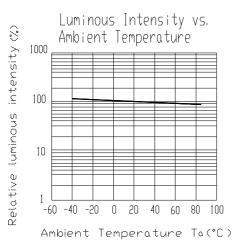


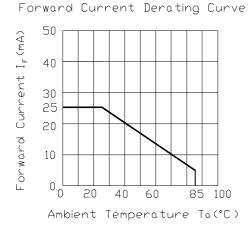


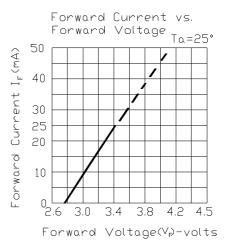
#### **Typical Electro-Optical Characteristics Curves**

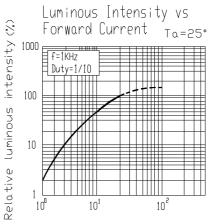
## BH

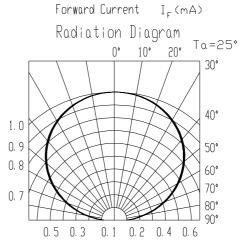








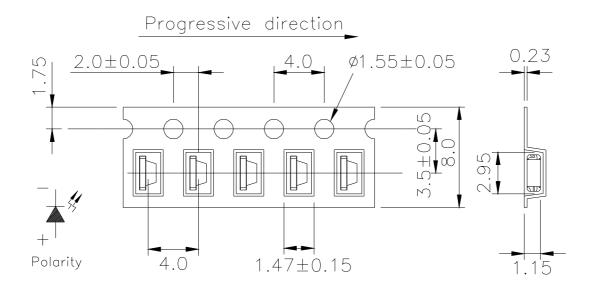






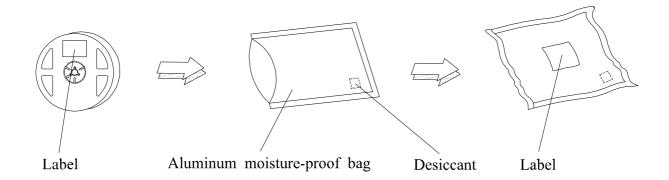


#### Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

#### **Moisture Resistant Packaging**







### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1







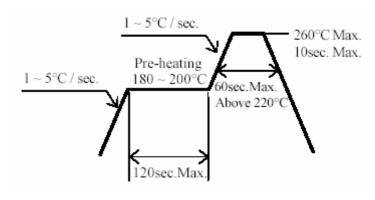
#### **Precautions For Use**

1. Customer must apply resistors for protection, otherwise a slight voltage shift will cause a big current change.

#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

  Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.



